

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (L<sup>2</sup>-π-MOSV)

# 2SK2846

Chopper Regulator, DC-DC Converter and Motor Drive Applications

- Low drain-source ON resistance : R<sub>DS (ON)</sub> = 4.2 Ω (typ.)
- High forward transfer admittance : |Y<sub>fs</sub>| = 1.7 S (typ.)
- Low leakage current : I<sub>DSS</sub> = 100 μA (max) (V<sub>DS</sub> = 600 V)
- Enhancement mode : V<sub>th</sub> = 2.0~4.0 V (V<sub>DS</sub> = 10 V, I<sub>D</sub> = 1 mA)

## Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	600	V
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		V <sub>DGR</sub>	600	V
Gate-source voltage		V <sub>GSS</sub>	±30	V
Drain current	DC (Note 1)	I <sub>D</sub>	2	A
	Pulse (t = 1 ms) (Note 1)	I <sub>DP</sub>	5	A
	Pulse (t = 100 μs) (Note 1)	I <sub>DP</sub>	8	A
Drain power dissipation		P <sub>D</sub>	1.3	W
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	93	mJ
Avalanche current		I <sub>AR</sub>	2	A
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	0.13	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	96.1	°C / W

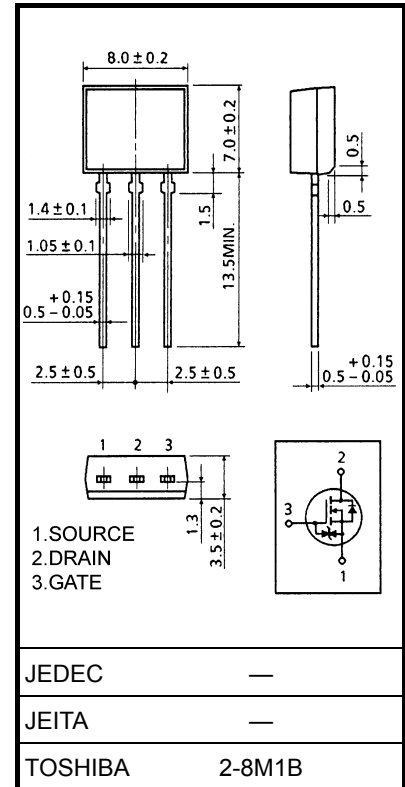
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V<sub>DD</sub> = 90 V, T<sub>ch</sub> = 25°C (initial), L = 41 mH, R<sub>G</sub> = 25 Ω, I<sub>AR</sub> = 2 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.  
Please handle with caution.

Unit: mm



Weight: 0.54 g (typ.)

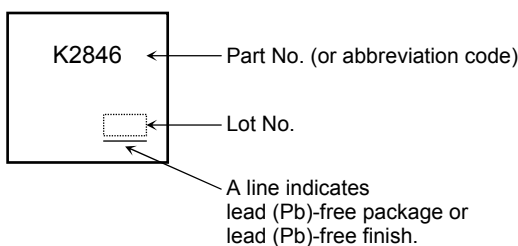
## Electrical Characteristics (Ta = 25°C)

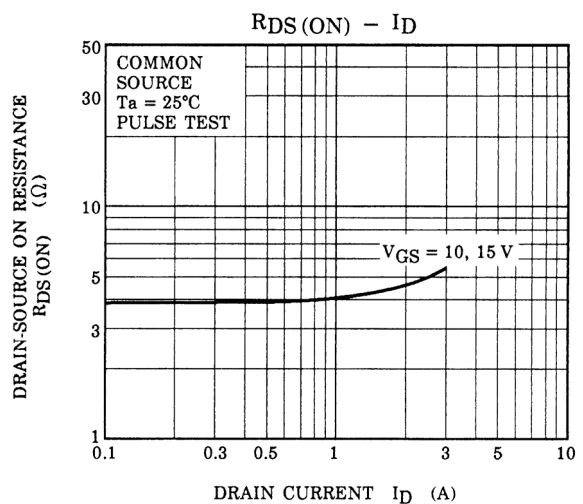
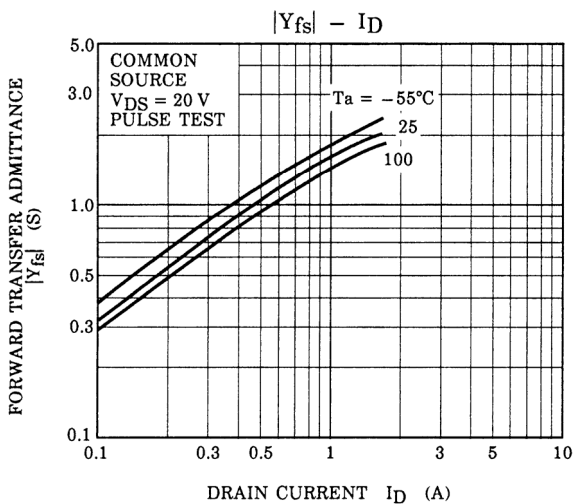
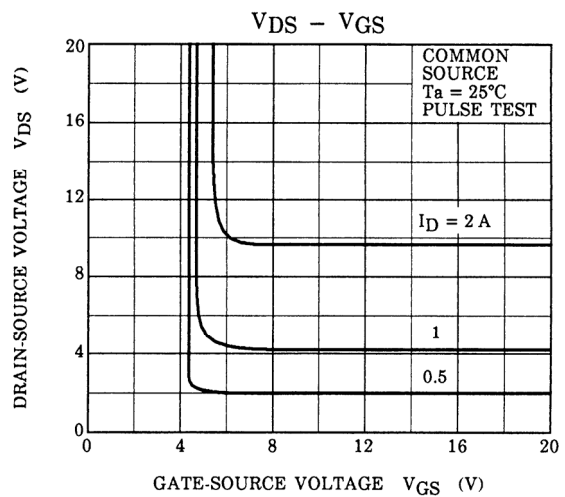
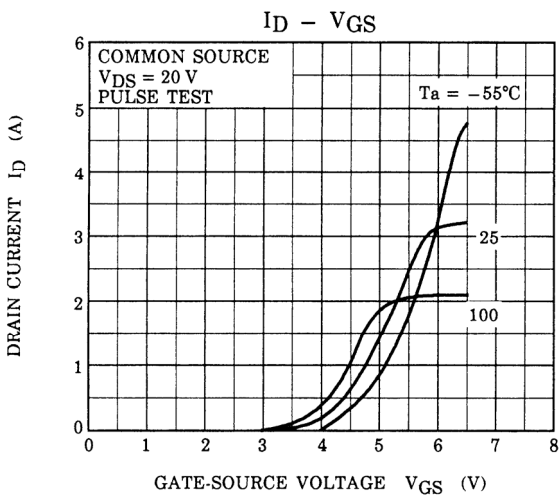
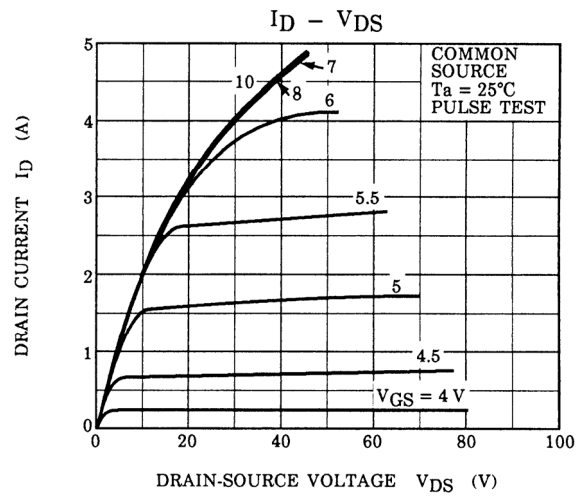
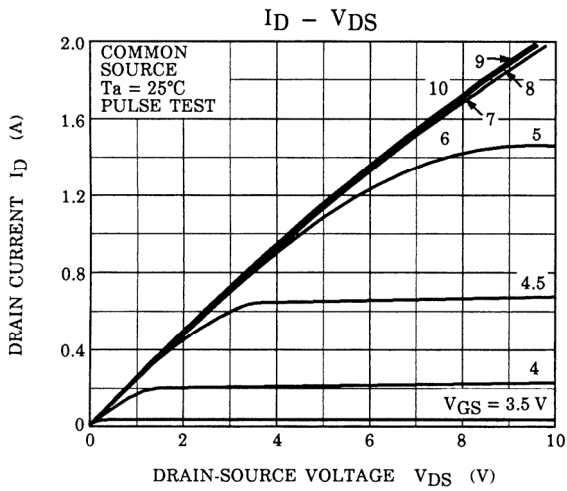
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 25\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Gate-source breakdown voltage		$V_{(BR)GSS}$	$I_D = \pm 10\ \mu\text{A}, V_{GS} = 0\text{ V}$	$\pm 30$	—	—	V
Drain cut-off current		$I_{DSS}$	$V_{DS} = 600\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	600	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2.0	—	4.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 1\text{ A}$	—	4.2	5.0	$\Omega$
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 1\text{ A}$	0.8	1.7	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	380	—	pF
Reverse transfer capacitance		$C_{rss}$		—	40	—	
Output capacitance		$C_{oss}$		—	120	—	
Switching time	Rise time	$t_r$	<p><math>I_D = 1\text{ A}</math>  <math>V_{GS} = 10\text{ V}</math>  <math>0\text{ V}</math>  <math>50\ \Omega</math>  <math>R_L = 200\ \Omega</math>  <math>V_{DD} = 200\text{ V}</math>                      Duty <math>\leq 1\%</math>, <math>t_w = 10\ \mu\text{s}</math></p>	—	15	—	ns
	Turn-on time	$t_{on}$		—	25	—	
	Fall time	$t_f$		—	20	—	
	Turn-off time	$t_{off}$		—	80	—	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 480\text{ V}, V_{GS} = 10\text{ V}, I_D = 2\text{ A}$	—	9	—	nC
Gate-source charge		$Q_{gs}$		—	5	—	
Gate-drain ("miller") Charge		$Q_{gd}$		—	4	—	

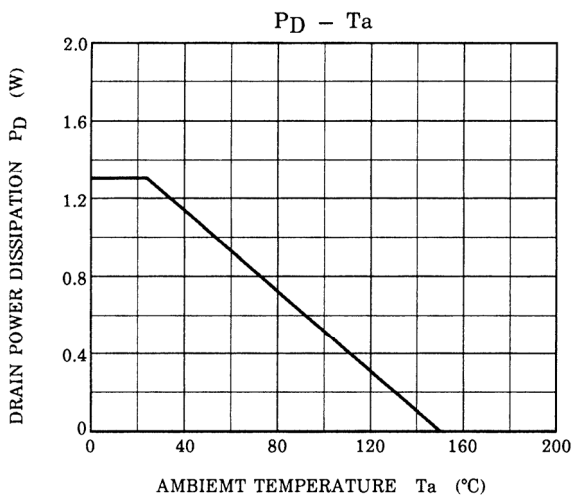
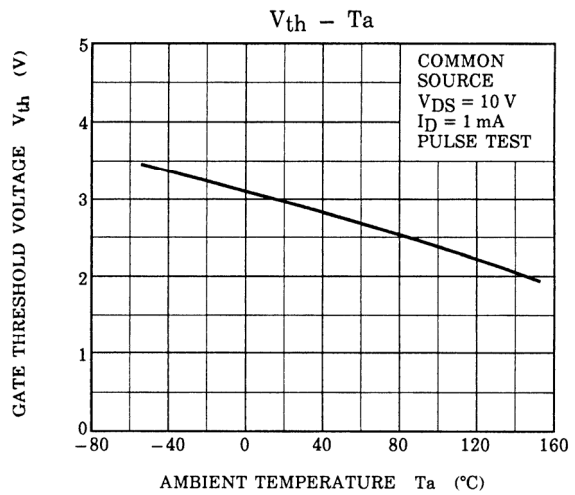
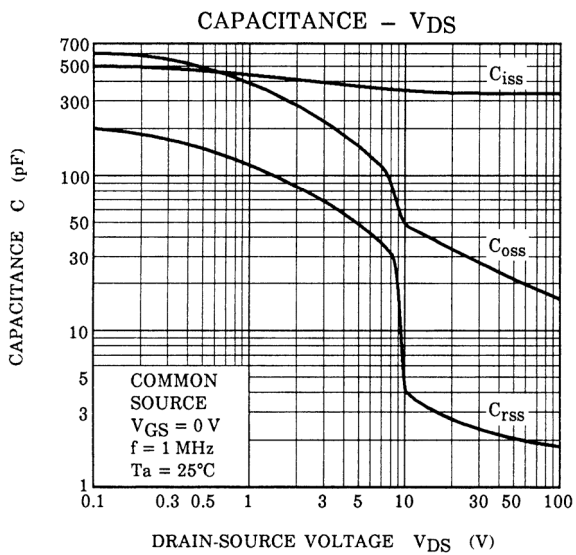
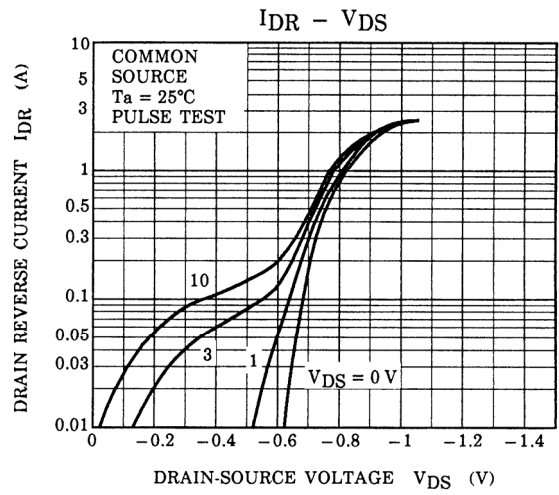
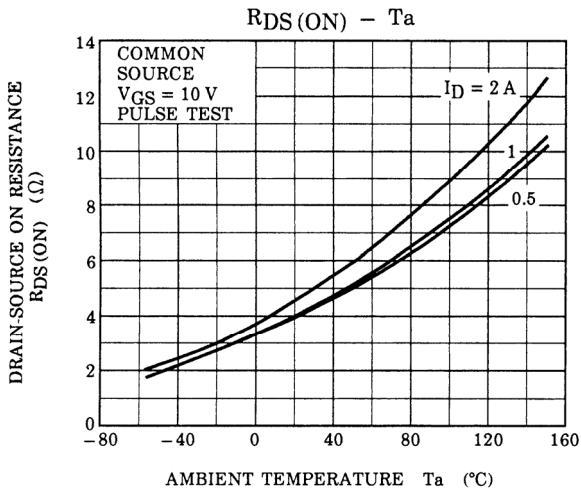
## Source-Drain Ratings and Characteristics (Ta = 25°C)

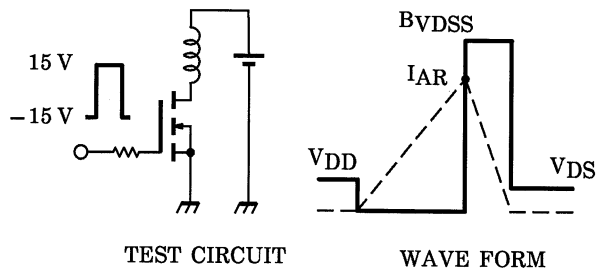
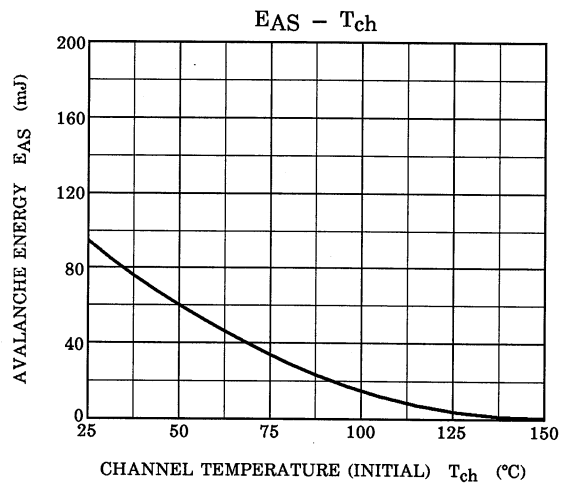
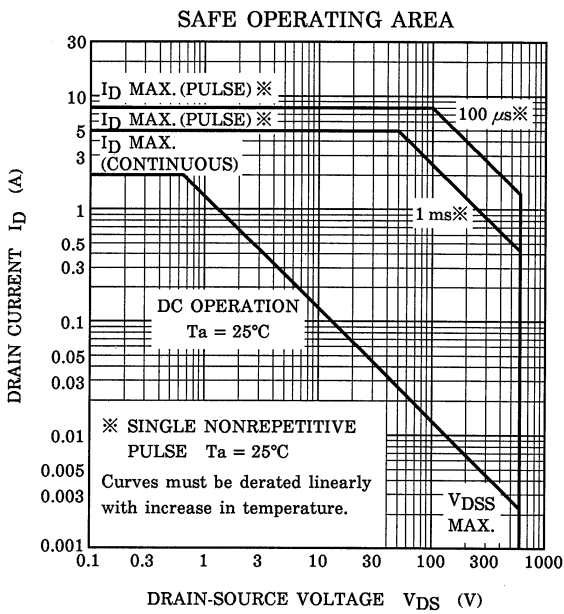
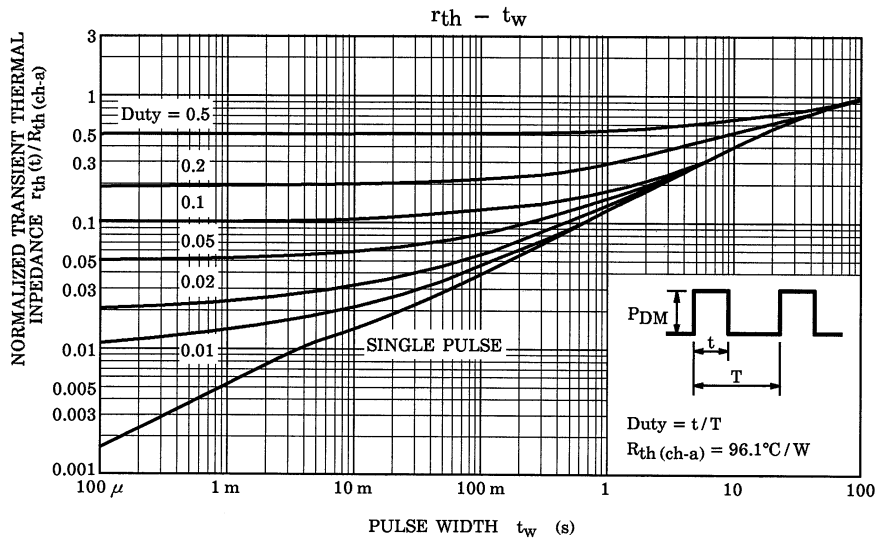
Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)		$I_{DR}$	—	—	—	2	A
Pulse drain reverse current (Note 1)		$I_{DRP}$	$t = 1\text{ ms}$	—	—	5	A
		$I_{DRP}$	$t = 100\ \mu\text{s}$	—	—	8	A
Forward voltage (diode)		$V_{DSF}$	$I_{DR} = 2\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.5	V
Reverse recovery time		$t_{rr}$	$I_{DR} = 2\text{ A}, V_{GS} = 0\text{ V}$	—	1000	—	ns
Reverse recovery charge		$Q_{rr}$	$dI_{DR} / dt = 100\text{ A} / \mu\text{s}$	—	3.5	—	$\mu\text{C}$

## Marking









$R_G = 25 \Omega$   
 $V_{DD} = 90 V, L = 41 mH$

$$EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{BVDSS}{BVDSS - V_{DD}} \right)$$

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